

DESCRIPTION

The IS357 series consists of an infrared light emitting diode optically coupled to an NPN silicon photo transistor in a space efficient Mini Flat Package.

FEATURES

- Low Profile Package
- AC Isolation Voltage 3750V_{RMS}
- Wide Operating Temperature Range -55°C to +110°C
- RoHS Compliant
- UL File E91231 model "FPT", "FPT1", "FPT2"

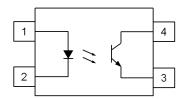
APPLICATIONS

- Computer Terminals
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedance

ORDER INFORMATION

 Available in Tape and Reel with 3000 pieces per reel





- Anode
- 2 Cathode
- 3 Emitter
- 4 Collector

ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current	50mA
Peak Forward Current (100µs, 100Hz)	1A
Reverse Voltage	6V
Power Dissipation	70mW
Junction Temperature	125°C

Output

Total Package

Operating Temperature -55 to +110°C Storage Temperature -55 to +150°C

Lead Soldering Temperature (10s) 260°C

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	V_{F}	$I_F = 20 \text{mA}$		1.2	1.4	V
Reverse Current	I_R	$V_R = 4V$			10	μΑ
Terminal Capacitance	C_{t}	V = 0V, $f = 1KHz$		30	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector-Emitter Breakdown Voltage	$\mathrm{BV}_{\mathrm{CEO}}$	$I_C = 0.1 \text{mA}, I_F = 0 \text{ mA}$	80			V
Emitter-Collector Breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E=10\mu A,I_F=0mA$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE}=20V,I_F=0mA$			100	nA

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	$I_F = 5 \text{mA}, V_{CE} = 5 \text{V}$	50		600	%
		Optional CTR Grades				
		IS357A	80		160	
		IS357B	130		260	
		IS357C	200		400	
		IS357D	300		600	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	$I_F = 20 \text{mA}, I_C = 1 \text{mA}$			0.2	V
Floating Capacitance	C_{f}	V = 0V, $f = 1MHz$		0.6	1	pF
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$ $Ic = 2mA$		4	18	μs
Output Fall Time	t_{f}	$R_{L} = 2mA$ $R_{L} = 100\Omega$		3	18	μs

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage	$V_{\rm ISO}$	RH = 40% to 60%, $t = 1$ min	3750			V_{RMS}
Isolation Resistance	$R_{\rm ISO}$	RH = 40% to 60% $V_{I-O} = 500 VDC$	5x10 ¹⁰	1x10 ¹¹		Ω

Measured with input leads shorted together and output leads shorted together.



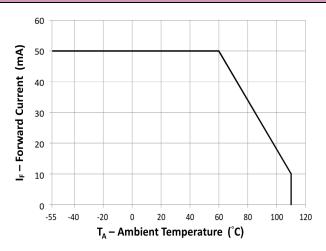


Fig 1 Forward Current vs Ambient Temperature

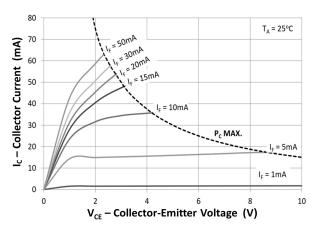


Fig 3 Collector Current vs Collector-Emitter Voltage

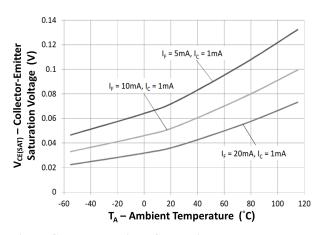


Fig 5 Collector-Emitter Saturation Voltage vs Ambient Temperature

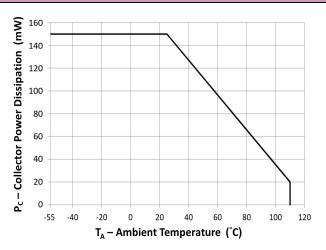


Fig 2 Collector Power Dissipation vs Ambient Temperature

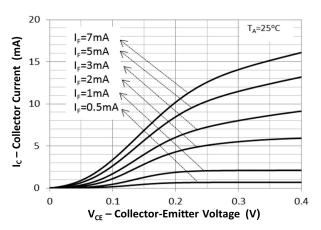


Fig 4 Collector Current vs Collector-Emitter Saturation Voltage

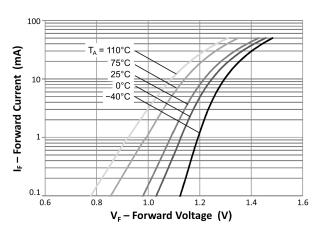


Fig 6 Forward Current vs Forward Voltage



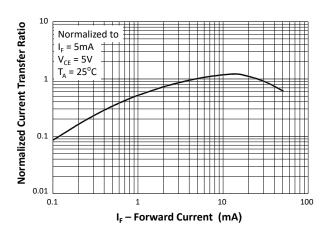


Fig 7 Normalized Current Transfer Ratio vs Forward Current

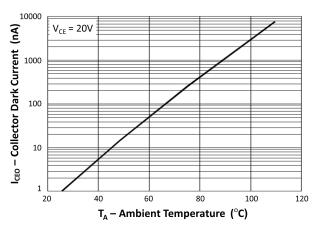


Fig 9 Collector Dark Current vs Ambient Temperature

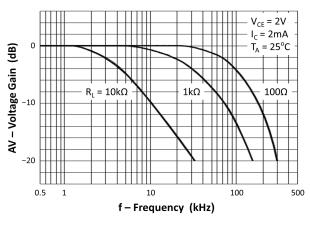


Fig 11 Frequency Response

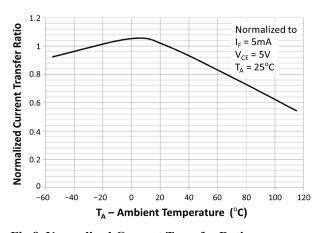


Fig 8 Normalized Current Transfer Ratio vs Ambient Temperature

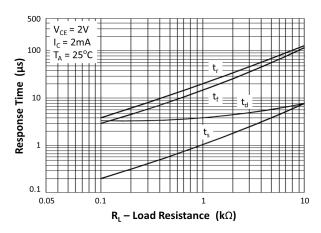
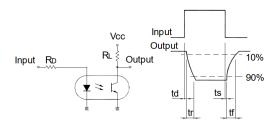
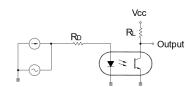


Fig 10 Response Time vs Load Resistance



Response Time Test Circuit



Frequency Response Test Circuit



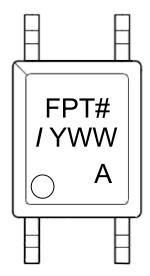
ORDER INFORMATION

IS357				
After PN	PN	Description	Packing quantity	
None	IS357	Surface Mount Tape & Reel	3000 pcs per reel	
Any CTR Grade	IS357A, IS357B IS357C, IS357D	Surface Mount Tape & Reel	3000 pcs per reel	

NOTE: Multiple Grades may be supplied to meet the requested specification.

DEVICE MARKING

Example: IS357A



FPT# Device Part Number where "#" is internal reference

can be "FPT", "FPT1" or "FPT2"

A CTR Grade

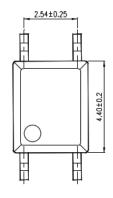
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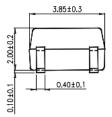
Y Year code (A=2010, B=2011, etc.)

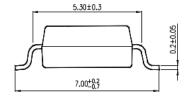
WW 2 digit Week code



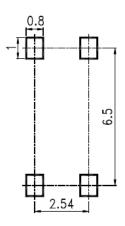
PACKAGE DIMENSIONS (mm)





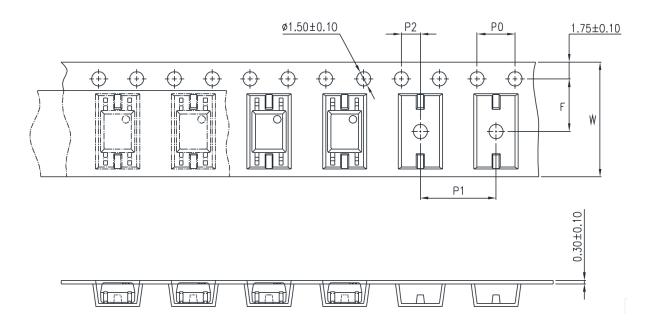


RECOMMENDED SOLDER PAD LAYOUT (mm)





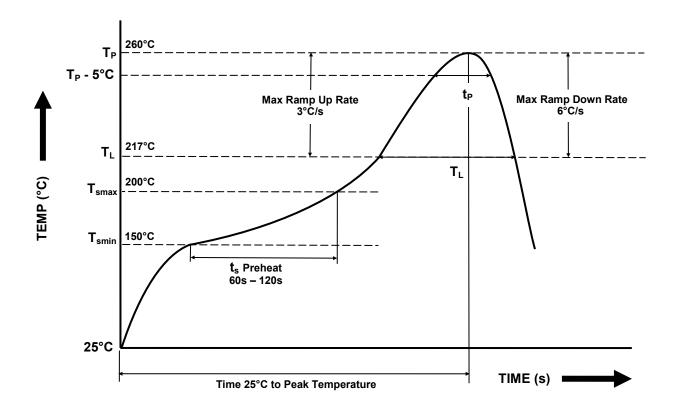
TAPE AND REEL PACKAGING



Description	Symbol	Dimension mm (inch)
Tape Width	W	12 ± 0.3 (0.47)
Pitch of Sprocket Holes	P ₀	4 ± 0.1 (0.157)
Distance of Compartment to Sprocket Holes	F	5.5 ± 0.1 (0.217)
Distance of Compartment to Sprocket Holes	P ₂	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P ₁	8 ± 0.1 (0.315)



IR REFLOW SOLDERING TEMPERATURE PROFILE One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time } T_{SMIN} \ \text{to } T_{SMAX} \left(t_{s} \right) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{lll} \textbf{Soldering Zone} \\ &- \mbox{Peak Temperature } (T_P) \\ &- \mbox{Time at Peak Temperature} \\ &- \mbox{Liquidous Temperature } (T_L) \\ &- \mbox{Time within } 5^{\circ}\mbox{C of Actual Peak Temperature } (T_P - 5^{\circ}\mbox{C}) \\ &- \mbox{Time maintained above } T_L (t_L) \\ &- \mbox{Ramp Up Rate } (T_L \mbox{ to } T_P) \\ &- \mbox{Ramp Down Rate } (T_P \mbox{ to } T_L) \\ \end{tabular}$	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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